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Image

1731



Patent Docket # 5123-27RCE

PATENT

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Application of  
Bassel H. DAOUD et al.  
Serial No.: 09/497,045  
Filed: February 02, 2000  
For: Mold Incorporating A Heat Source And  
Apparatus And Method For Using Such Molds

Examiner: Halpern, Mark  
Group Art: 1731

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September 9, 2003  
(Date of Deposit)

Lance J. Lieberman  
Name of Applicant, assignee or Registered Representative

*[Signature]*  
Signature

September 9, 2003  
Date of Signature

Mail Stop Amendment  
Commissioner for Patents  
P.O. Box 1450  
Alexandria, VA 22313-1450

**SUPPLEMENTAL REVISED AMENDMENT**

SIR:

In response to the September 03, 2003 Notice of Non-Compliant Amendment, applicants resubmit herewith a complete "Amendments to the Claims" section of its prior Amendment, which herewith-submitted section has been corrected to remedy the deficiencies noted in the September 03, 2003 Notice of Non-Compliant Amendment.

**Amendments to the Claims** are reflected in the listing of claims which begins on page 02 of this paper.

**Remarks** begin on page 08 of this paper.